

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FII	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/875,197	06/07/2001		Joon-Young Yang	8733.132.20	8761
30827	7590	12/29/2004		EXAMINER	
MCKENNA LONG & ALDRIDGE LLP				RAO, SHRINIVAS H	
1900 K STREET, NW WASHINGTON, DC 20006		•	ART UNIT	PAPER NUMBER	
Wildim(d101), BC 20000				2814	

DATE MAILED: 12/29/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

•			A1,					
		Application No.	Applicant(s)					
		09/875,197	YANG, JOON-YOUNG					
-	Office Action Summary	Examiner	Art Unit					
		Steven H. Rao	2814					
Period fo	The MAILING DATE of this communication ap or Reply	ppears on the cover sheet with the	correspondence address					
THE - Exter after - If the - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPLEMALLING DATE OF THIS COMMUNICATION. Insions of time may be available under the provisions of 37 CFR 1. SIX (6) MONTHS from the mailing date of this communication. It is period for reply specified above is less than thirty (30) days, a regular to reply within the set or extended period for reply will, by statustic reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	.136(a). In no event, however, may a reply be ply within the statutory minimum of thirty (30) of d will apply and will expire SIX (6) MONTHS fro te, cause the application to become ABANDO	timely filed tays will be considered timely, om the mailing date of this communication. NED (35 U.S.C. § 133).	/				
Status								
1)	Responsive to communication(s) filed on 24.5	September 2004.						
,	This action is FINAL . 2b) This action is non-final.							
· · ·	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Dispositi	ion of Claims							
5) 6) 7)	Claim(s) 41-56 is/are pending in the application 4a) Of the above claim(s) is/are withdraware Claim(s) is/are allowed. Claim(s) 41-56 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/	awn from consideration.						
Applicati	ion Papers							
9)[The specification is objected to by the Examin	er.						
10)	The drawing(s) filed on is/are: a) ac	cepted or b) objected to by the	e Examiner.					
	Applicant may not request that any objection to the	e drawing(s) be held in abeyance. S	See 37 CFR 1.85(a).					
_	Replacement drawing sheet(s) including the corre							
11)[_]	The oath or declaration is objected to by the E	Examiner. Note the attached Office	ce Action or form PTO-152.					
Priority (ınder 35 U.S.C. § 119							
12)	Acknowledgment is made of a claim for foreig All b) Some * c) None of:	n priority under 35 U.S.C. § 119	(a)-(d) or (f).					
	1. Certified copies of the priority documer	nts have been received.						
	2. Certified copies of the priority documer	nts have been received in Applica	ation No					
	3. Copies of the certified copies of the pri	ority documents have been rece	ived in this National Stage					
	application from the International Burea							
* (See the attached detailed Office action for a lis	st of the certified copies not recei	ved.					
Attachmen	nt(s)							
1) Notic	ce of References Cited (PTO-892)	4) Interview Summa						
3) 🔲 Infor	ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08 er No(s)/Mail Date	Paper No(s)/Mail 5) Notice of Informa 6) Other:	Date al Patent Application (PTO-152)					
C Dotont and T	Frademark Office							

Art Unit: 2814

Response to Amendment

Applicants' amendment filed on September 24, 2004 has been entered and forwarded to the Examiner on September 29, 2004.

Therefore claims 41 and 55 as amended by the amendment and claims 42-54 and 56 as previously presented are currently pending in the Application.

Claim Rejections - 35 USC # 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action.

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 41-56 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamaguchi (U.S. Patent No. 5,897,346, herein after Yamaguchi) previously applied and in view of Aomori et al. (U.S. Patent No. 5,504,020, herein after Aomori).

With respect to claim 41 Yamaguchi describes a method of fabricating a thin film transistor, comprising forming a gate insulating layer on an active layer (Yamaguchi fig. IB # 13, col. 8 lines and fig. IC # 14), forming a gate on the gate insulating layer forming an excited region in an exposed portion of the active layer by implanting hydrogen ions to the active layer by using the gate as a mask (figs. 1 C and A); and

Art Unit: 2814

forming an impurity region by heavily implanting impurity ions to said excited region in a heavy dosage while the excited region remains in an excited state, (Fig. 1 C implanting P+ ions Yamaguchi col. 9 lines 14 and figs. IC, etc. describe heavily implanting ions,). (It is noted that Yamaguchi discloses the use of active layer as a mask and implanting prior to the formation of the gate. However it would be an obvious altering of the sequence of steps to implant the H after gate formation. Further as Applicants' claims use the terminology "comprising" the claim includes steps in any sequence)

Yamaguchi does not specifically disclose the limitation, "and has a temperature high enough to self-activate the impurity ions and whereby impurity ions become self-activated".

However, Aomori, a patent from the same filed of endeavor, describes in col.3 lines 13 to 25 ion shower doping method wherein heavy doping/implantation of Hydrogen ions the impurity ions are self-activated in the polycrystalline thin film to fabricate TFTS at low temperature thereby allowing the use of low temperature melting materials to be used and to control the precise amount of Hydrogen to be implanted is attained thereby a TFT with higher reliability is obtained. And in col. 11 lines 53-55 teaches the temperature high enough to self-activate the impurity ions (Aomori teaches temperature in the range 0-450 which includes the 200-300 taught by Applicants).

Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to include Aomori's step of heavy ion doping which causes the impurity

Art Unit: 2814

ions to be self-activated in Yamaguchi's method. The motivation to include Aomori's afore mention steps in to Yamaguchi's method are to fabricate TFTS at low temperature thereby allowing the use of low temperature melting materials to be used and to control the precise amount of Hydrogen to be implanted is attained thereby a TFT with higher reliability is obtained. (Aomori col. 2 and col. 4 lines 20 to 55).

With respect to claim 42 Yamaguchi describes the method of claim 41, wherein the gate insulating layer is formed by depositing silicon dioxide or silicon nitride on a glass substrate. (Yamaguchi col. 8 line 2).

Wiih respect to claim 43 Yamaguchi describes t he method of claim 41, wherein the active layer is formed by depositing undoped polycrystalline silicon. (Yamaguchi col. 7 line 50).

With respect to claim 44, Yamaguchi describes the method of claim 43, wherein the undoped polycrystalline silicon has a thickness of between about 400 and 800 A. (Yamaguchi col. 7 line 47).

With respect to claim 45 Yamaguchi describes the method of claim 43, wherein the active layer is formed using chemical vapor deposition process. (Yamaguchi col. 7 line 48)

With respect to claim 46 Yamaguchi describes the method of claim 41, wherein the active layer is formed by depositing amorphous silicon and crystallizing the amorphous silicon by laser annealing. (Yamaguchi col. 7 lines 46-51).

With respect to claim 47, Yamaguchi describes the method of claim 4, wherein the exposed portion of the active layer is formed by the steps of depositing an another

Art Unit: 2814

layer of silicon dioxide on the gate insulating layer to cover the active layer, depositing a conductive material on the another layer of silicon dioxide, and patterning the conductive material and the another layer of silicon dioxide to form an insulating layer and to form the gate over a selected portion of the active layer. (Yamaguchi Fig. 3 E).

With respect to claim 48 Yamaguchi describes the method of claim 47, wherein the gate insulating layer and the gate comprise a thickness of about 500-1500 A and, about 1500-:2500 A, respectively. (Yamaguchi col. 8 lines 2 and 5).

With respect to claim 49 Yamaguchi describes the method of claim 41, wherein said hydrogen ions are implanted with implantation energy between about 50 and 150 KeV. (Yamaguchi col. 9 line 15).

With respect to claim 50 Yamaguchi describes the method of claim 41, wherein id hydrogen ions are implanted with a dose of between about $5 \times 10^{14} - 5 \times 10^{16}$ ions/cm sq (Yamaguchi col. 9 line 14).

With respect to claim 51 Yamaguchi describes the method of claim 49, wherein said hydrogen ions are implanted to heat up the excited region to a temperature between about 200-300 degrees Celsius. (Yamaguchi col.9 line 15 and 54).

With respect to claim 52 Yamaguchi describes the method of claim 50, wherein said hydrogen ions are implanted to heat up the excited region to a temperature between about 200-300 degrees Celsius. (Yamaguchi col.9 line 15 and 54).

With respect to claim 53, Yamaguchi describes the method of claim 41, wherein said hydrogen ions are implanted in the active layer and simultaneously form the impurity region. (It is inherent when a dopant is implanted an impurity region is

Art Unit: 2814

formed).

With respect to claim 54, Yamaguchi describes the method of claim 41, wherein the hydrogen ion implantation time is proportionately related to the size of the active layer. (inherent because bigger the area the longer it will take).

With respect to claim 55, Yamaguchi describes a thin film transistor prepared by a process comprising'. forming a gate insulating layer on an active layer, forming a gate on the gate insulating layer, forming an excited region in an exposed portion of the active layer by implanting hydrogen ions to the active layer by using the gate as a mask; and forming an impurity region by implanting impurity ions to said excited region while the excited region remains in an excited state and has a temperature high enough to self-activate the impurity ions, wherein the activation of said impurity ions implanted heavily occurs as the step of said implanting impurity ions is performed. (rejected for same reasons as claim 41 above).

With respect to claim 56 Yamaguchi describes the thin film transistor of claim 55, wherein the, gate insulating layer is formed by depositing silicon dioxide or silicon nitride on a glass substrate, and the active layer is formed by depositing undoped polycrystalline silicon. (rejected for same reasons as claim 42).

Response to Arguments

Applicant's arguments filed 08/24/2004 have been fully considered but they are not persuasive for the following reasons:

Art Unit: 2814

It is noted that the outstanding rejection is based on the combined teachings of Yamaguchi and Aomori whereas all of applicants' arguments are based on the alleged deficiencies of the primary reference Yamaguchi only.

It is well settled law that Applicants' piece meal analysis of the references, it has been held that one cannot show non-obviousness by attacking references individually where as here, the rejections are based on combinations of references. See In re Keller , 208 USPQ 871 (CCPA 1981) .

It is noted that , the rejection cites Aomori, a patent from the same filed of endeavor, describes in col.3 lines 13 to 25 ion shower doping method wherein heavy doping/implantation of Hydrogen ions the impurity ions are self-activated in the polycrystalline thin film to fabricate TFTS at low temperature and it not necessary for the primary Yamaguchi reference to also teach what is at least taught by the secondary Aomori reference.

Applicants' contention that the presently newly added limitation, "the excited region... has a temperature high enough to self-activate the impurity ions." is not taught by the applied references is not persuasive because the limitation is taught by Aomori e.g. col. 11 lines 53-55 and claim 4 at temperatures 450 degrees or less which includes the range of 200-300 degrees stated in Applicants' specification and recited in claim 52.

Applicants' next contention that Yamaguchi's teachings should be limited to "
post annealing process" and therefore is a separate process different from hydrogen
implantation process" is not persuasive because see Yamaguchi figs. IC and A, fig. IC

Art Unit: 2814

implanting P+ ions, and col. 8 lines 24-25 describe the activation occurring while the implanting is performed.

Further, it is well settled law that "The performance of two steps simultaneously, which have previously been performed in sequence was held to have been obvious. In re Tantincloux 108 USPQ 125 (CCPA 1955). See also In re Gibson, 39 F.2d. 975, 5 USPQ 230 (CCPA 1930).

Therefore even limiting Yamaguchi's teachings as suggested by Applicants'

Yamaguchi performing the implantation and annealing steps in sequence renders the simultaneous performance of the same two steps for the same purposes in the presently recited claims obvious.

Applicants' contention with respect to claim 55, that Yamaguchi and Aomori do not teach the recited, "forming an impurity region by implanting impurity ions to said excited region while the excited region remains in an excited state and has a temperature high enough to self-activate the impurity ions, wherein the activation of said impurity ions implanted occurs as the step of said implanting impurity ions is performed" is not persuasive because forming an impurity region by implanting impurity ions to said excited region while the excited region remains in an excited state <u>as stated above is taught by the applied references and</u> forming an impurity region by heavily implanting impurity ions to said excited region in a, heavy dosage while the excited region remains in an excited state, (Fig. 1 C implanting P+ ions Yamaguchi col. 9 lines 14 and figs. IC, etc. describe heavily implanting ions,). (It is noted that Yamaguchi discloses the use of active layer as a mask and implanting prior to the formation of the gate. However it

would be an obvious altering of the sequence of steps to implant the H after gate formation. Further as Applicants' claims use the terminology "comprising" the claim includes steps in any sequence).

"Has a temperature high enough to self-activate the impurity ions," as stated above is taught by <u>Aomori</u>, a patent from the same filed of endeavor, describes in <u>col.3</u> <u>lines 13 to 25</u> ion shower doping method wherein heavy doping/implantation of Hydrogen ions the impurity ions are self-activated in the polycrystalline thin film. See also Yamaguchi figs. IC and A, fig. IC implanting P+ ions, and col. 8 lines 24-25 describe the activation occurring while the implanting is performed.

Therefore none of Applicants' arguments are persuasive.

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Steven H. Rao whose telephone number is (703) 3065945. The examiner can normally be reached on 8.00 to 5.00.

The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Steven H. Rao

Patent Examiner

November 29, 2004.

HOWARD WEISS PRIMARY EXAMINER